

APPLICATIONS

- ✓ Ethernet - 10/100 Base T
- ✓ RS-458
- ✓ xDSL & ATM
- ✓ SCSI & USB
- ✓ Audio/Video I/O Ports

IEC COMPATIBILITY (EN61000-4)

- ✓ 61000-4-2 (ESD): Air - 15kV, Contact - 8kV
- ✓ 61000-4-4 (EFT): 40A - 5/50ns
- ✓ 61000-4-5 (Surge): 24A, 8/20 μ s Level 2 (Line-Ground) & Level 3 (Line-Line)

FEATURES

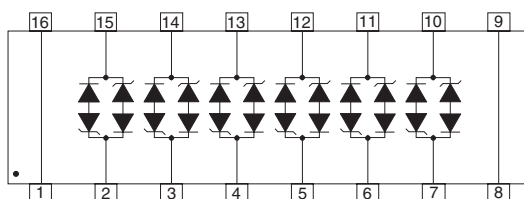
- ✓ 800 Watts Peak Pulse Power per Line ($t_p=8/20\mu s$)
- ✓ Bidirectional Configuration
- ✓ ESD Protection > 40 kilovolts
- ✓ Available in 5 Voltage Types: 5V to 24V
- ✓ Standard Dual-In-Line Package
- ✓ Protects up to 6 Lines
- ✓ Low Capacitance: 15pF
- ✓ RoHS Compliant

MECHANICAL CHARACTERISTICS

- ✓ Molded 16 Pin Dual-In-Line (DIP) Package
- ✓ Weight 1.2 grams (Approximate)
- ✓ Available in Lead-Free Pure-Tin Plating (Annealed)
- ✓ Solder Reflow Temperature:
Pure-Tin - Sn, 100: 260-270°C
- ✓ Consult Factory For Leaded Device Availability
- ✓ Flammability Rating UL 94V-0
- ✓ Packaging: 25 Pieces Per Tube
- ✓ Marking: Logo, Part Number, Date Code & Pin One Defined By Dot on Top of Package



PIN CONFIGURATION



LCA05C thru LCA24C

DEVICE CHARACTERISTICS

MAXIMUM RATINGS @ 25°C Unless Otherwise Specified

PARAMETER	SYMBOL	VALUE	UNITS
Peak Pulse Power ($t_p = 8/20\mu s$) - See Figure 1	P_{PP}	800	Watts
Operating Temperature	T_L	-55 to 150	°C
Storage Temperature	T_{STG}	-55 to 150	°C

ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified

PART NUMBER (See Note 1)	RATED STAND-OFF VOLTAGE V_{WM} VOLTS	MINIMUM BREAKDOWN VOLTAGE @ 1mA $V_{(BR)}$ VOLTS	MAXIMUM CLAMPING VOLTAGE (See Fig. 2) @ $I_p = 1A$ V_C VOLTS	MAXIMUM CLAMPING VOLTAGE (See Fig. 2) @ 8/20 μs V_C @ I_{PP}	MAXIMUM LEAKAGE CURRENT @ V_{WM} I_b μA	MAXIMUM CAPACITANCE 0V @ 1 MHz C pF	TEMPERATURE COEFFICIENT OF $V_{(BR)}$ $qV_{(BR)}$ mV/°C
LCA05C	5.0	6.0	9.8	24V @ 45A	100	15	3
LCA08C	8.0	8.5	12.3	25.5V @ 40A	10	15	9
LCA12C	12.0	13.3	19.0	32V @ 34A	4	15	16
LCA15C	15.0	16.7	25.5	38V @ 27A	4	15	17
LCA24C	24.0	26.7	40.0	48V @ 22A	4	15	26

Note 1: Tested on pin pairs 1 & 16, 2 & 15, 3 & 14, 4 & 13, 5 & 12, 6 & 11, 7 & 10 and 8 & 9.

**FIGURE 1
PEAK PULSE POWER VS PULSE TIME**

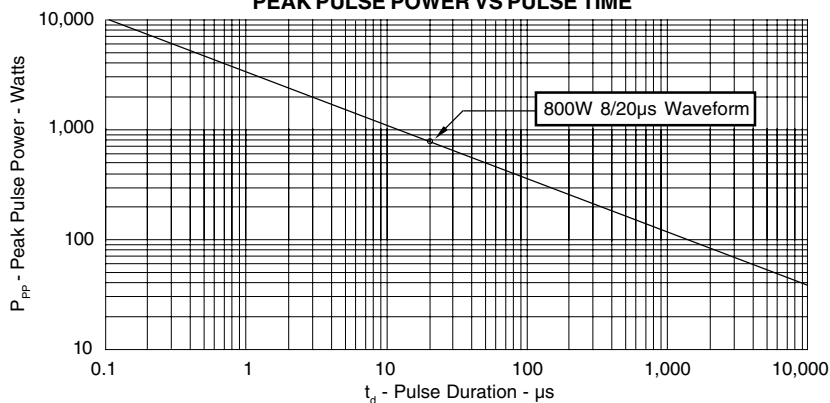
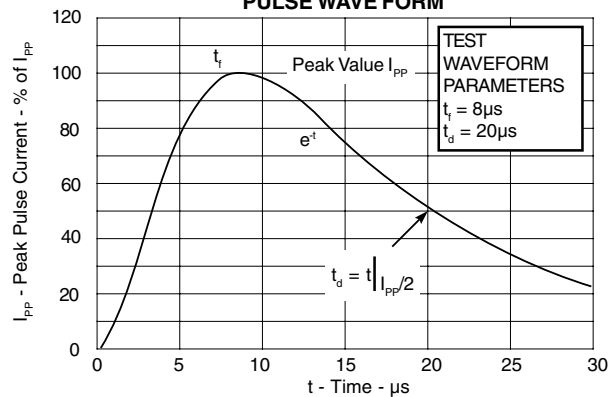


**FIGURE 2
PULSE WAVE FORM**



GRAPHS

**FIGURE 3
POWER DERATING CURVE**

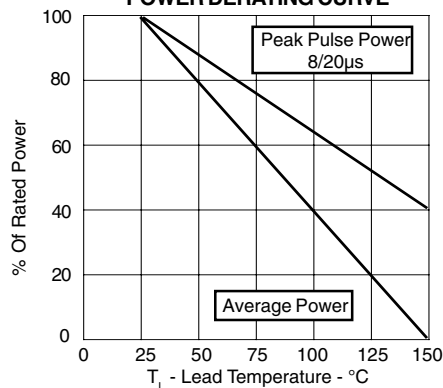


**FIGURE 4
OVERSHOOT & CLAMPING VOLTAGE FOR LCA05C**

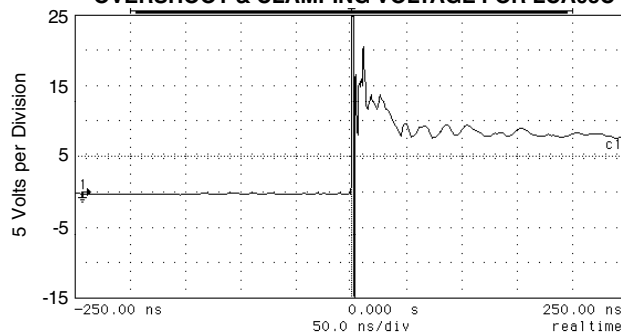
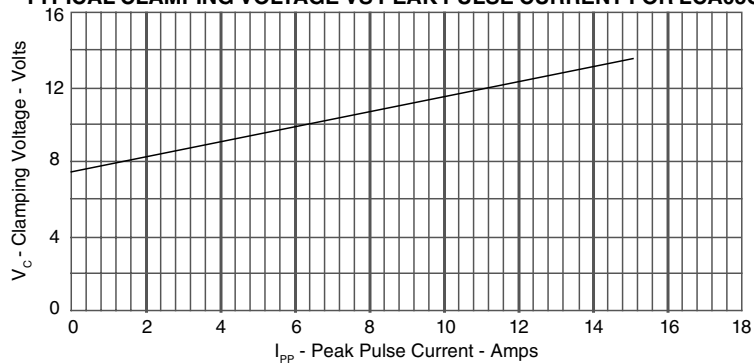


**FIGURE 5
TYPICAL CLAMPING VOLTAGE VS PEAK PULSE CURRENT FOR LCA05C**



APPLICATION NOTE

The LCA Series are low capacitance, bidirectional TVS arrays that are designed to protect I/O or high speed data lines from the damaging effects of ESD or EFT. This product series has a surge capability of 800 Watts P_{PP} per line for an 8/20 μ s waveshape and offers ESD protection > 40kV.

BIDIRECTIONAL COMMON-MODE CONFIGURATION (Figure 1)

Ideal for use in USB applications, the LCA Series provides up to six (6) lines of protection in a common-mode configuration as depicted in Figure 1.

Circuit connectivity is as follows:

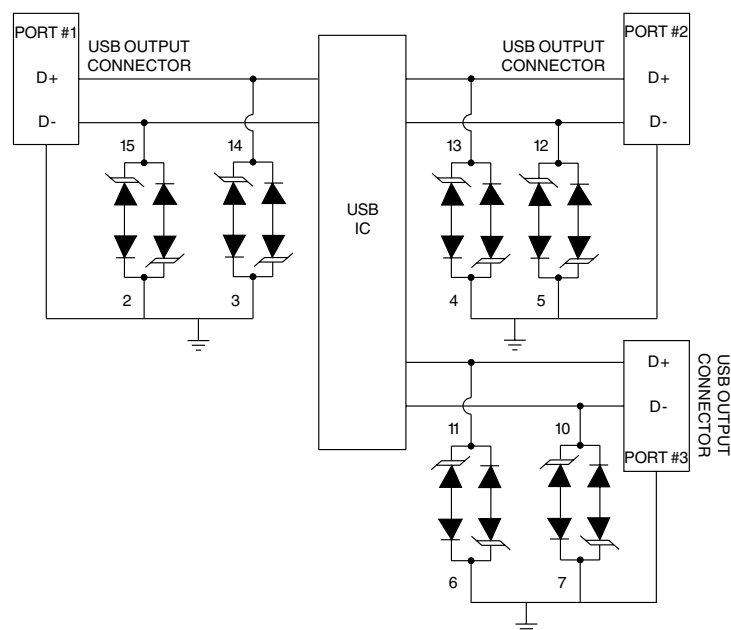
- ✓ Pins 2, 3, 4, 5, 6, and 7 are connected to ground.
- ✓ Pins 15 and 14 connected to Port #1 D- and D+.
- ✓ Pins 13 and 12 connected to Port #2 D+ and D-.
- ✓ Pins 11 and 10 connected to Port #3 D+ and D-.

CIRCUIT BOARD LAYOUT RECOMMENDATIONS

Circuit board layout is critical for Electromagnetic Compatibility (EMC) protection. The following guidelines are recommended:

- ✓ The protection device should be placed near the input terminals or connectors. By placing the TVS close to the connectors, the device will divert the transient current immediately before it can be coupled into the nearby traces.
- ✓ The path length between the TVS devices and the protected line should be minimized
- ✓ All conductive loops including power and ground loops should be minimized
- ✓ The transient current return path to ground should be kept as short as possible to reduce parasitic inductance.
- ✓ Ground planes should be used whenever possible. For Multilayer PCBs, use ground vias.

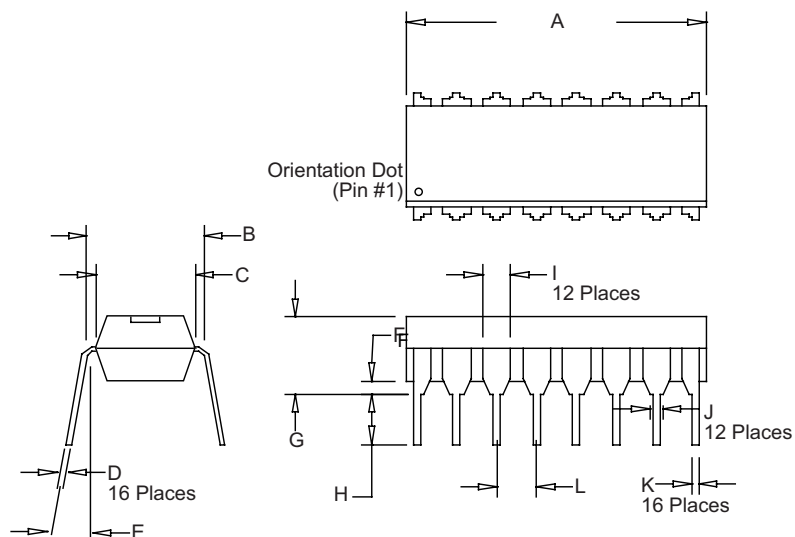
Figure1. Typical Common- Mode USB Protection Circuit



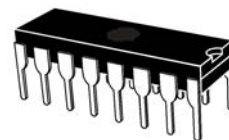
LCA05C thru LCA24C

16 PIN DIP PACKAGE OUTLINE & DIMENSIONS

PACKAGE OUTLINE



16 PIN DIP



DIMENSIONS

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	-	19.8	-	0.780
B	7.37	7.87	0.290	0.310
C	6.10	6.60	0.240	0.260
D	0.25	0.50	0.010	0.020
E	0°	10°	0°	10°
F	0.51	-	0.020	-
G	-	5.08	-	0.200
H	3.17	-	0.125	-
I	-	1.78	-	0.070
J	0.84 TYP	0.84 TYP	0.033 TYP	0.033 TYP
K	0.38	0.53	0.015	0.021
L	2.54 TYP	2.54 TYP	0.100 TYP	0.100 TYP

NOTES:

1. Dimensions are exclusive of mold flash and metal burrs.

BULK ORDERING NOMENCLATURE:

1. No Suffix = Product Shipped in Tubes of 25 pcs per Tube.
2. Suffix - LF = Lead-Free, Pure-Tin Plating, i.e., LCA05C-LF.

Outline & Dimensions: Rev 1 - 11/01, 06003

COPYRIGHT © ProTek Devices 2007

SPECIFICATIONS: ProTek reserves the right to change the electrical and or mechanical characteristics described herein without notice (except JEDEC).

DESIGN CHANGES: ProTek reserves the right to discontinue product lines without notice, and that the final judgement concerning selection and specifications is the buyer's and that in furnishing engineering and technical assistance, ProTek assumes no responsibility with respect to the selection or specifications of such products.

ProTek Devices

2929 South Fair Lane, Tempe, AZ 85282

Tel: 602-431-8101 Fax: 602-431-2288

E-Mail: sales@protekdevices.com

Web Site: www.protekdevices.com